

2.2x1.4mm SURFACE MOUNT LED LAMP

Part Number: AA2214QWS/D

White



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE

DEVICES

Features

- 2.2mm x 1.4mm, 1.3mm high.
- Low power consumption.
- Available on tape and reel.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

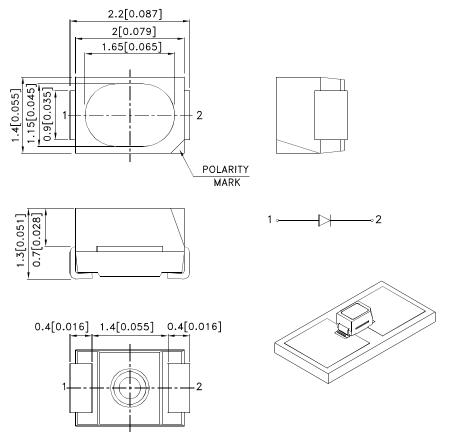
The source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



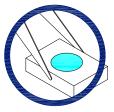
- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

DATE: FEB/09/2011 SPEC NO: DSAK1878 **REV NO: V.2** PAGE: 1 OF 7 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1201005716

Handling Precautions

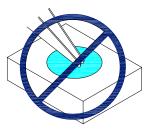
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

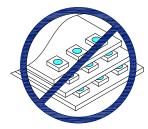


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

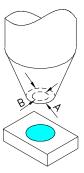




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

SPEC NO: DSAK1878 REV NO: V.2 DATE: FEB/09/2011 PAGE: 2 OF 7
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: D.M.Su ERP: 1201005716

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
AA2214QWS/D	White (InGaN)	Water Clear	400	550	120°

- θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

2100th out 7 Option Characteriotics at 171 20 0							
Symbol	Parameter	Device Typ.		Max.	Units	Test Conditions	
VF [1]	Forward Voltage	White	3.3	4.0	V	IF=20mA	
lR	Reverse Current	White		50	uA	V _R = 5V	
x [2]	Chromoticity Coordinates	\0/l=:4-	0.31				
y [2]	Chromaticity Coordinates	White	0.31				
С	Capacitance	White	100		pF	VF=0V;f=1MHz	

- 1. Forward Voltage: +/-0.1V.
- 2: Measurement Tolerance Of The Chromaticity Coordinates Is ±0.01.

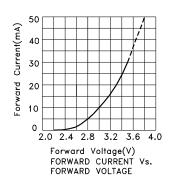
Absolute Maximum Ratings at TA=25°C

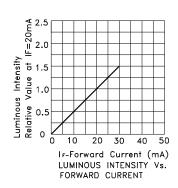
Parameter	White			
Power dissipation	120	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C	4		
Storage Temperature	-40°C To +85°C			

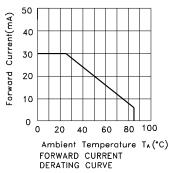
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

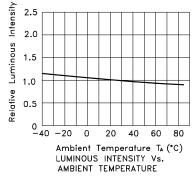
SPEC NO: DSAK1878 REV NO: V.2 DATE: FEB/09/2011 PAGE: 3 OF 7 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1201005716

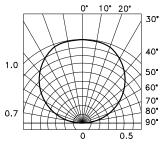
White AA2214QWS/D











SPATIAL DISTRIBUTION

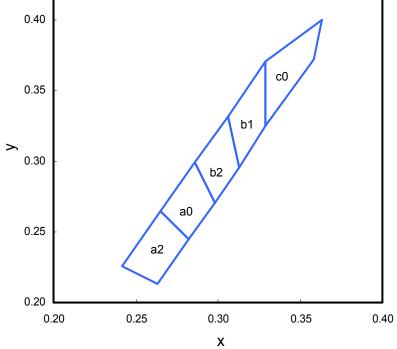
 SPEC NO: DSAK1878
 REV NO: V.2
 DATE: FEB/09/2011
 PAGE: 4 OF 7

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: D.M.Su
 ERP: 1201005716





White CIE



	х	У		х	у		х	у
	0.263	0.213	a0	0.282	0.245		0.298	0.271
a2	0.282	0.245		0.298	0.271	b2	0.313	0.296
αz	0.265	0.265		0.286	0.299	UZ	0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
	0.313	0.296	c0	0.329	0.325			
b1	0.329	0.325		0.358	0.372			
51	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

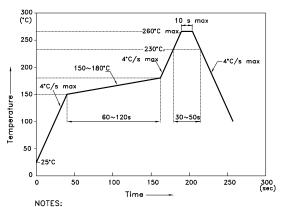
Notes: Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ±0.01.

DATE: FEB/09/2011 SPEC NO: DSAK1878 REV NO: V.2 PAGE: 5 OF 7 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1201005716

AA2214QWS/D

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



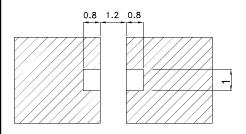
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed
 - to high temperature.

 3.Number of reflow process shall be 2 times or less.

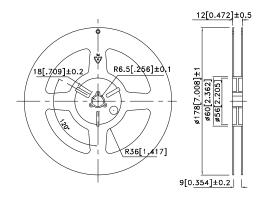
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

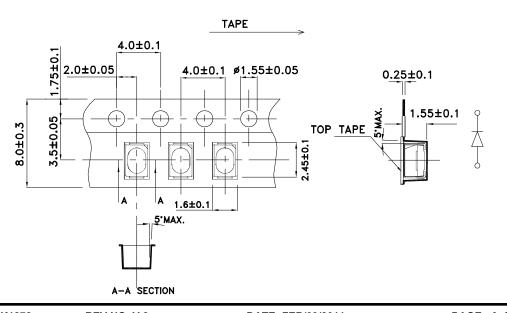


Solder Resist

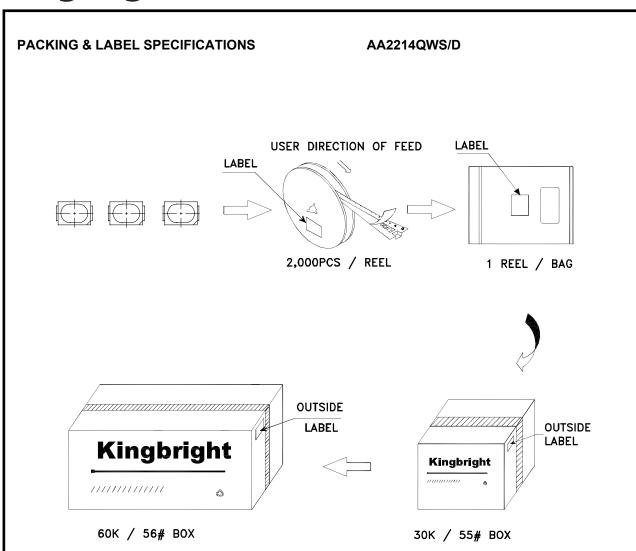
Tape Dimensions (Units: mm)

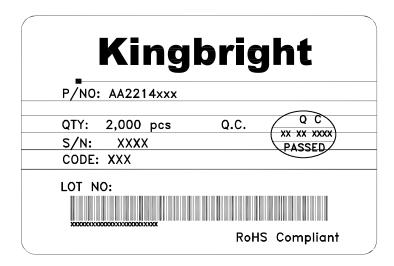
Reel Dimension





SPEC NO: DSAK1878 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu DATE: FEB/09/2011 DRAWN: D.M.Su PAGE: 6 OF 7 ERP: 1201005716





SPEC NO: DSAK1878 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu DATE: FEB/09/2011 DRAWN: D.M.Su PAGE: 7 OF 7 ERP: 1201005716